IPC  ASSOCIATION CONNECT ELECTRONICS INDUSTR	Material Compos © Copyright 2005. IPC international and Pan-A	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard  Form Typ  http://www.ipc.org/IPC-175x  Form Typ  Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					ials and Mfg Information				
Supplier Infor	mation														
Company name* Company			Company un	any unique ID			Unique ID Authority					Response Date*			
nsemi												2023-06-08			
Contact Name		Title - Contact			Phone	Phone - Contact*					Email - Contact*				
Product-Env-Stev	wards		Product Enviro Compliance			NA	NA				Product-Env-Stewards@onsemi.com				
uthorized Repre	sentative*		Title - Representative			Phone	Phone - Representative*				Email - Representative*				
Product-Env-Stev	wards	Product Enviro Compliance			NA	NA				Product-Env-Stewards@onsemi.com					
Reques	Requester Item Number Mfr Ite		mem Number Mfr Item Name			Effect	tive Date	Date Version Manufacturing Site		V	Weight*	UOM	Unit Type		
				OR NA; Two phase drive		-06-08	PHM		1	30.0	mg	Each			
	g Process Informatio		' 10	A 11	COED 020 MOL D	I.D.	) 1 D	D 1 T	<u>.</u>	M Ti (D.)	T	N. 1	SD G G	1	
ů ,					I-STD-020 MSL Rating		Peak Process Body Tempera 260 C						er of Reflow Cyc	les	
contain	R RI	C	U Alloy	3	,	2	70U		Ľ	30	secon	ds 3			
omments	OF A D . It's		D 1 / 6	1 1											
	SL 3 Rated item requires E		`												
r more informa	tion regarding material co	mposition p	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's Itaalian applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	5.34	mg	Supplier	Silicon (Si)	7440-21-3		5.3202	mg
			Supplier	Polyimide	Proprietary Data		0.0198	mg
Die Attach	0.43	mg	Supplier	Silver (Ag)	7440-22-4		0.3289	mg
			Supplier	Epoxy resins	129915-35-1		0.1011	mg
Lead Frame	15.4	mg	Supplier	Zinc (Zn)	7440-66-6		0.0293	mg
			Supplier	Iron (Fe)	7439-89-6		0.3989	mg
			Supplier	Copper (Cu)	7440-50-8		14.9503	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0216	mg
Mold Compound-Black	106.96	mg		Epoxy Phenol Resin	proprietary data		11.7656	mg
			Supplier	Carbon Black (C)	1333-86-4		0.5348	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		48.6668	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		45.9928	mg
Plating	1.72	mg	В	Bismuth (Bi)	7440-69-9		0.0103	mg
			Supplier	Tin (Sn)	7440-31-5		1.7097	mg
Wire Bond - Cu	0.15	mg	Supplier	Copper (Cu)	7440-50-8		0.15	mg